

Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
30	0.0195 at V _{GS} = 10 V	8	9.2 nC			
50	0.023 at V_{GS} = 4.5 V	8	3.2 110			

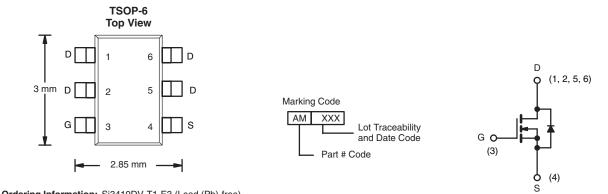
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Notebook Load Switch
- Low Current dc-to-dc





N-Channel MOSFET

Orde	ring mornation. Sistion - 11-ES (Lead (FD)-nee)
	Si3410DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T	$_{\Lambda}$ = 25 °C, unless othe	rwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage			30	v
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		8 ^a	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		8 ^a	
Continuous Drain Gurrent (1j = 130°C)	T _A = 25 °C	I _D	7.5 ^{b,c}	
	T _A = 70 °C	Ι Γ	5.9 ^{b,c}	А
Pulsed Drain Current	I _{DM}	30		
Continuous Source-Drain Diode Current	T _C = 25 °C	L.	2.7	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	1.7 ^{b,c}	
	T _C = 25 °C		4.1	
Maximum Power Dissipation	T _C = 70 °C	D.	2.6	w
Maximum Power Dissipation	T _A = 25 °C	PD	2 ^{b,c}	
	T _A = 70 °C	1 [1.25 ^{b,c}	1
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	45	62.5	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	25	30	0/11	

Notes:

a. Package Limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under Steady State conditions is 110 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•	<u> </u>	<u></u>
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V$, $I_{D} = 250 \mu A$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μΑ		33		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6.2		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zaus Cata Visita as Dusis Convert	1	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	20			А
	P	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		0.016	0.0195	Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4 \text{ A}$		0.019	0.023	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 5 A		24		S
Dynamic ^b			•		·	•
Input Capacitance	C _{iss}			1295		
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		170		pF
Reverse Transfer Capacitance	C _{rss}			72		
· · · · · · · · · · · · · · · · · · ·	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		21.8	33	nC
Total Gate Charge				9.2	14	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		3.8		
Gate-Drain Charge	Q _{gd}			2.5		
Gate Resistance	R _g	f = 1 MHz		2.4		Ω
Turn-On Delay Time	t _{d(on)}			21	40	
Rise Time	t _r	V_{DD} = 15 V, R_L = 3 Ω		14	25	-
Turn-Off DelayTime	t _{d(off)}	${ m I_D}\cong 5~{ m A},~{ m V_{GEN}}$ = 4.5 V, ${ m R_g}$ = 1 Ω		20	40	
Fall Time	t _f	-		9	18	
Turn-On Delay Time	t _{d(on)}			10	20	ns
Rise Time	t _r	V_{DD} = 15 V, R_L = 3 Ω		8	16	
Turn-Off DelayTime	t _{d(off)}	$\text{I}_\text{D}{\cong}5$ A, V_GEN = 10 V, R_g = 1 Ω		21	35	
Fall Time	t _f	-		8	16	1
Drain-Source Body Diode Characterist	ics					
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			2.7	^
Pulse Diode Forward Current	I _{SM}				30	A
Body Diode Voltage	V _{SD}	I _S = 1.7 A, V _{GS} = 0 V		0.77	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			21	40	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 3 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		15	30	nC
Reverse Recovery Fall Time	t _a	$F = 3 \text{ A}, \text{ u/ul} = 100 \text{ A/}\mu\text{s}, T_{\text{J}} = 25 \text{ C}$		13		
Reverse Recovery Rise Time	t _b			8		ns

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

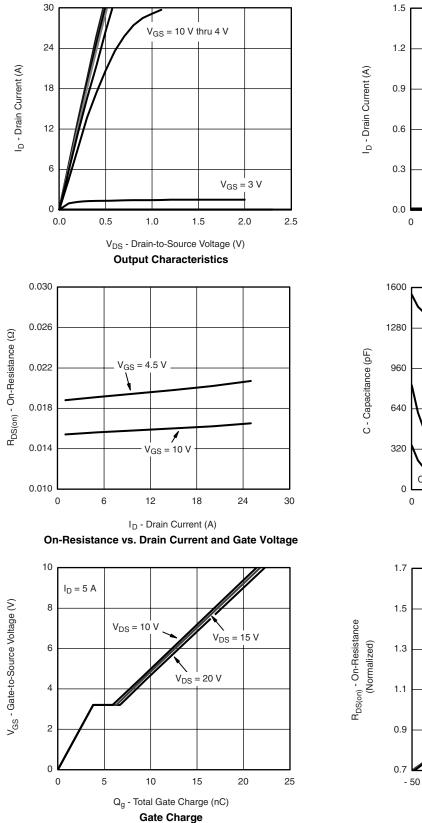
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

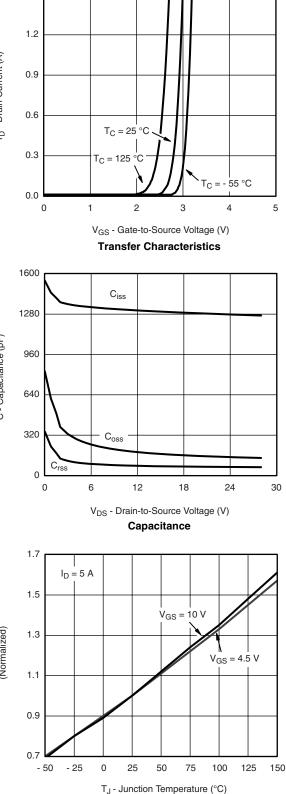


Si3410DV

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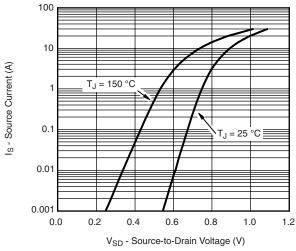


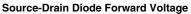
On-Resistance vs. Junction Temperature

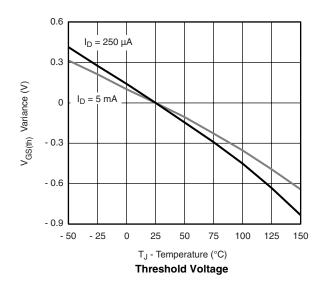


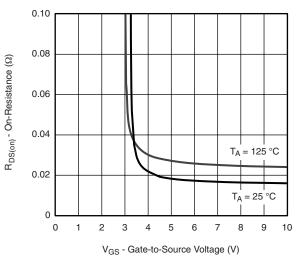
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

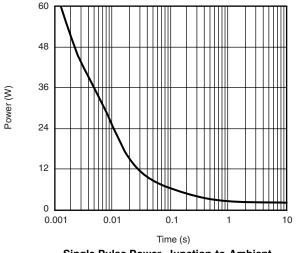


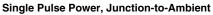


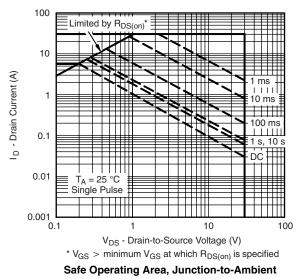




On-Resistance vs. Gate-to-Source Temperature

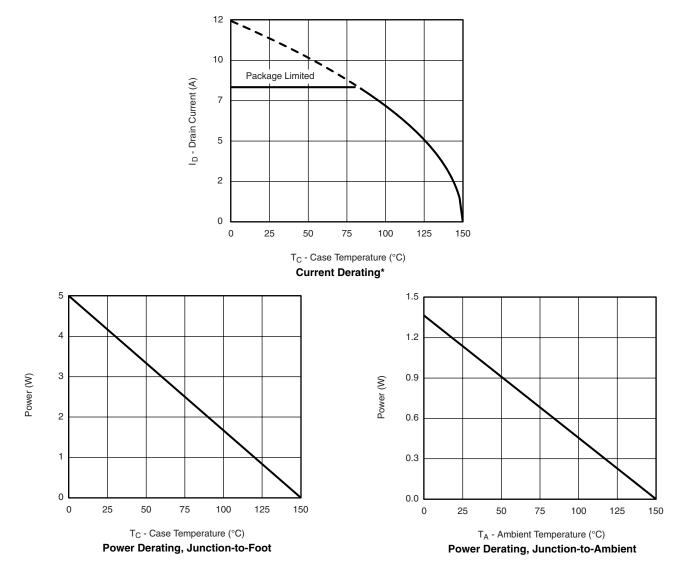








TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

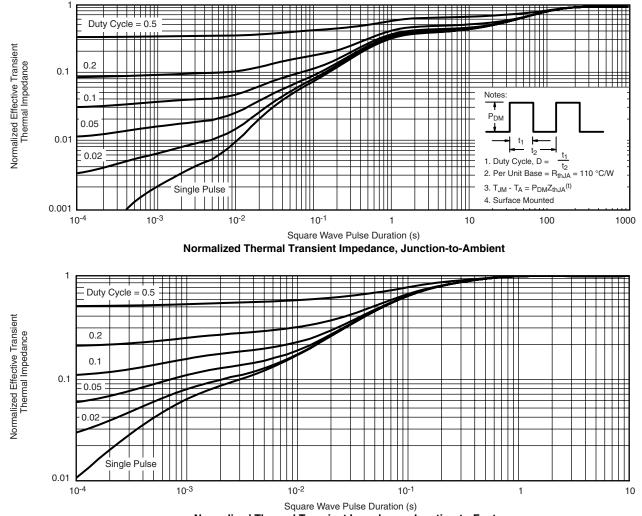


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?69254</u>.



Package Information

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TSOP: 5/6-LEAD JEDEC Part Number: MO-193C









6-LEAD TSOP



	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.95 BSC			0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁		0.60 Ref			0.024 Ref		
L ₂	0.25 BSC				0.010 BSC		
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ_1	7° Nom				7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

PAD Pattern



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Recommended Land Pattern For TSOP-5L / TSOP-6L





TSOP 5L





Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022	
DWG: 3010	

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Revision: 01-Jan-2025

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